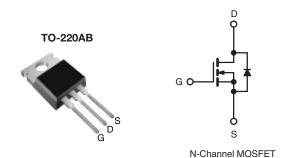


Vishay Siliconix

### Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	200				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 0.40				
Q <sub>g</sub> (Max.) (nC)	43				
Q <sub>gs</sub> (nC)	7.0				
Q <sub>gd</sub> (nC)	23				
Configuration	Single				



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF630PbF
	SiHF630-E3
SnPb	IRF630
	SiHF630

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	200	V	
Gate-Source Voltage			$V_{GS}$	± 20	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		9.0		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	5.7	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	36		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	250	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	9.0	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	74	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	ns (Peak Temperature) for 10 s			300 <sup>d</sup>	7	
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD} = 50 \text{ V}$ , starting  $T_J = 25 \, ^{\circ}\text{C}$ ,  $L = 4.6 \, \text{mH}$ ,  $R_g = 25 \, \Omega$ ,  $I_{AS} = 9.0 \, \text{A}$  (see fig. 12).
- c.  $I_{SD} \le 9.0$  A,  $dI/dt \le 120$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	$R_{thJA}$	-	62			
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	$R_{thJC}$	-	1.7			

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		200	-		V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.24	-	V/°C
Gate-Source Threshold Voltage	$V_{GS(th)}$	V <sub>DS</sub> =	$V_{GS}$ , $I_{D} = 250 \mu A$	2.0	-	4.0	V
Gate-Source Leakage	$I_{GSS}$		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		= 200 V, V <sub>GS</sub> = 0 V V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	25 250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		-	-	0.40	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 50 V, I <sub>D</sub> = 5.4 A	3.8	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	800	-	pF
Output Capacitance	C <sub>oss</sub>	]	$V_{DS} = 25 \text{ V},$	-	240	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1	.0 MHz, see fig. 5	-	76	-	
Total Gate Charge	Qg			-	-	43	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 5.9 \text{ A}, V_{DS} = 160 \text{ V},$ see fig. 6 and $13^b$	-	-	7.0	nC
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	23	
Turn-On Delay Time	t <sub>d(on)</sub>			-	9.4	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 100 V, $I_{D}$ = 5.9 A, $R_{g}$ = 12 $\Omega$ , $R_{D}$ = 16 $\Omega$ , see fig. 10 <sup>b</sup>		-	28	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	39	-	
Fall Time	t <sub>f</sub>			-	20	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	ml I
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
<b>Drain-Source Body Diode Characteristic</b>	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	9.0	А
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	_	36	
Body Diode Voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 9.0  \text{A},  V_{GS} = 0  \text{V}^b$		-	-	2.0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 5.9 A, dl/dt = 100 A/μs		-	170	340	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	1.1	2.2	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

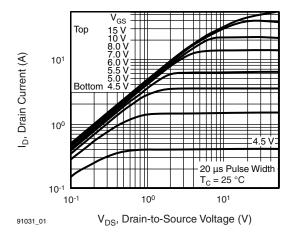


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

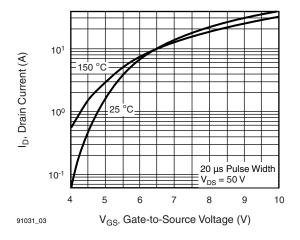


Fig. 3 - Typical Transfer Characteristics

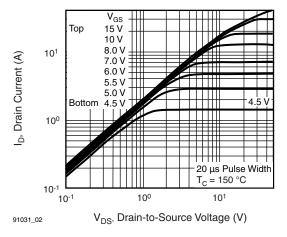


Fig. 2 -Typical Output Characteristics, T<sub>C</sub> = 150 °C

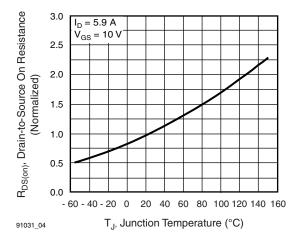


Fig. 4 - Normalized On-Resistance vs. Temperature

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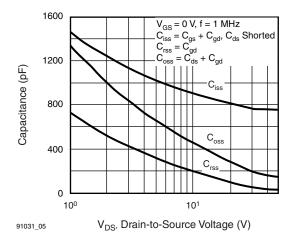


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

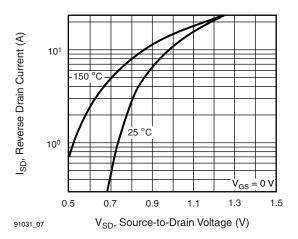


Fig. 7 - Typical Source-Drain Diode Forward Voltage

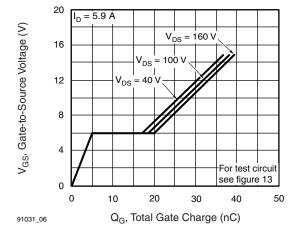


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

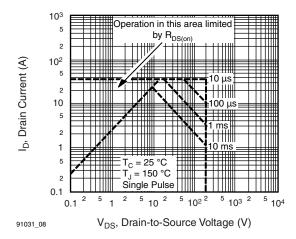


Fig. 8 - Maximum Safe Operating Area



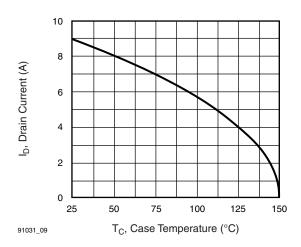


Fig. 9 - Maximum Drain Current vs. Case Temperature

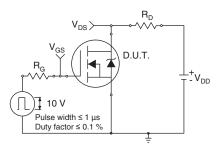


Fig. 10a - Switching Time Test Circuit

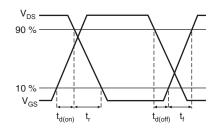


Fig. 10b - Switching Time Waveforms

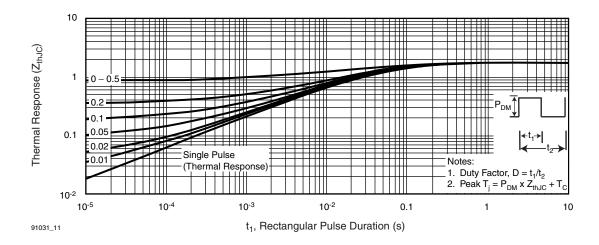


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

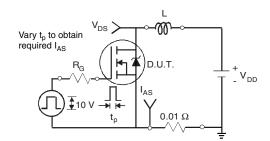


Fig. 12a - Unclamped Inductive Test Circuit

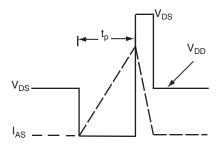


Fig. 12b - Unclamped Inductive Waveforms



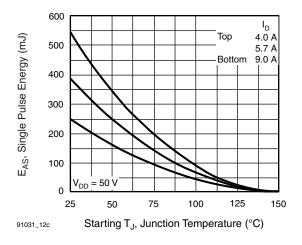


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

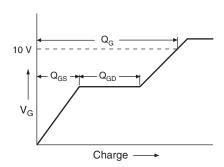


Fig. 13a - Basic Gate Charge Waveform

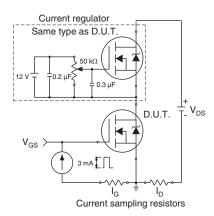
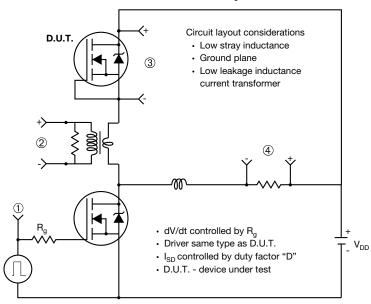


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



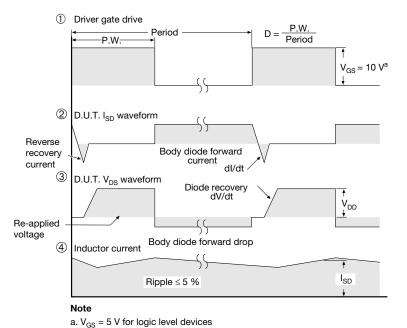


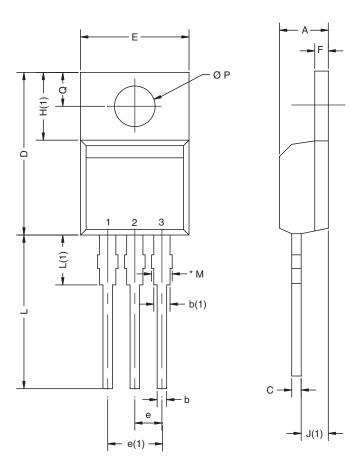
Fig. 14 - For N-Channel

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### **TO-220AB**



	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

DWG: 5471

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

Document Number: 71195 Revison: 01-Nov-10

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